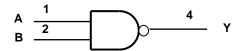


# **Pin Descriptions**

Pin Name	Pin No.	Description	
Α	1	Data Input	
В	2	Data Input	
GND	3	Ground	
Υ	4	Data Output	
V <sub>CC</sub>	5	Supply Voltage	

# **Logic Diagram**



#### **Function Table**

Inp	Output	
Α	В	Υ
Н	Н	L
L	X	Н
Х	L	Н



## **Absolute Maximum Ratings (Note 2)**

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
$V_{CC}$	Supply Voltage Range	-0.5 to 6.5	V
$V_{I}$	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.5 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Current V <sub>I</sub> <0	-20	mA
l <sub>OK</sub>	Output Clamp Current (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±20	mA
Io	Continuous output current (V <sub>O</sub> = 0 to V <sub>CC</sub> )	±25	mA
I <sub>CC</sub>	Continuous current through V <sub>CC</sub>	50	mA
I <sub>GND</sub>	I <sub>GND</sub> Continuous current through GND		mA
TJ	T <sub>J</sub> Operating Junction Temperature		°C
T <sub>STG</sub>	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values

# **Recommended Operating Conditions (Note 3)**

Symbol		Parameter	Min	Max	Unit
$V_{CC}$	Operating Voltage		4.5	5.5	V
$V_{IH}$	High-level Input Voltage		2.0		V
$V_{IL}$	Low-level input voltage			0.8	V
VI	Input Voltage		0	5.5	V
Vo	Output Voltage		0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current			-8	mA
I <sub>OL</sub>	Low-level output current			8	mA
Δt/ΔV	Input transition rise or fall rate			20	ns/V
T <sub>A</sub>	Operating free-air temperature		-40	125	°C

Notes: 3. Unused inputs should be held at V<sub>CC</sub> or Ground.



#### **Electrical Characteristics**

0	D	Table Canadidiana	V		25°C		-40°C t	o 85ºC	-40°C to	125ºC	I I a li
Symbol	Parameter	Test Conditions	V <sub>CC</sub>	Min	Тур.	Max	Min	Max	Min	Max	Unit
.,	High Level	$I_{OH} = -50\mu A$	4.5V	4.4	4.5		4.4		4.4		.,
V <sub>OH</sub>	Output Voltage	$I_{OH} = -8mA$	4.5V	3.94			3.8		3.70		V
V	Low Level	$I_{OL} = 50\mu A$	4.5V		0	0.1		0.1		0.1	\/
V <sub>OL</sub>	Output Voltage	$I_{OL} = 8mA$	4.5V			0.36		0.44		0.55	V
II	Input Current	$V_I = 5.5V$ or GND	0 to 5.5V			± 0.1		± 1		±2	μA
Icc	Supply Current	$V_I = 5.5V$ or GND $I_{O}=0$	5.5V			1		10		40	μA
C <sub>i</sub>	Input Capacitance	$V_I = V_{CC} - or$ GND	5.5V		2.0	10		10		10	pF
ΔI <sub>CC</sub>	Additional Supply Current	One input at 3.4V Other inputs at V <sub>CC</sub> or GND	5.5V			1.35		1.5			mA
	Thermal Resistance	SOT25	() ( )		204						00.004
$\theta_{JA}$	Junction-to- Ambient	SOT353	(Note 4)		371						°C/W
	Thermal Resistance	SOT25	(NI=4= 4)		52						90.00
θ <sub>JC</sub>	Junction-to- Case	SOT353	(Note 4)		143						°C/W

Note: 4. Test conditions for SOT25, and SOT353: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

# **Switching Characteristics**

 $V_{CC} = 5V \pm 0.5V$  (see Figure 1)

Doromotor	From	то			25°C		-40°C t	o 85ºC	-40°C to	125ºC	Unit
Parameter	(Input)	(OUTPUT)		Min	Тур.	Max	Min	Max	Min	Max	Onit
	۸ or D	V	C <sub>L</sub> =15pF	0.6	3.6	6.2	0.6	7.1	0.6	8.0	ns
t <sub>pd</sub> A or B		3 Y	C <sub>L</sub> =50pF	0.6	5.0	7.9	0.6	9.0	0.6	10.0	ns

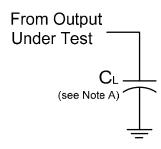
# **Operating Characteristics**

 $T_A = 25$  °C

Parameter		Test Conditions	V <sub>CC</sub> = 5V Typ.	Unit
C <sub>pd</sub>	Power dissipation capacitance	f = 1 MHz No Load	11	pF



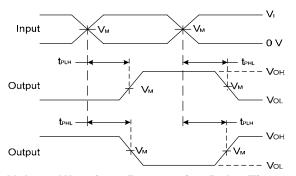
#### **Parameter Measurement Information**



Vcc	In	puts	V	C
VCC	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	CL
5V±0.5V	3 V	≤3ns	1.5V	15pF
5V±0.5V	3 V	≤3ns	1.5V	50pF



**Voltage Waveform Pulse Duration** 



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
- C. Inputs are measured separately one transition per measurement.
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd.}$



### **Ordering Information**

<u>74 AHCT 1G 00 XX - 7</u> Logic Device **Function** Package **Packing** 74: Logic Prefix W5: SOT25 7: Tape & Reel 00: 2-Input

AHCT: 2 to 5.5V

NAND-Gate

**SE: SOT353** 

Family with TTL

input level

1G: One gate

	Device Package Packagir		Packaging	7" Tape and Reel		
	Device	Code	(Note 5)	Quantity	Part Number Suffix	
<b>Pb</b> ,	74AHCT1G00W5-7	W5	SOT25	3000/Tape & Reel	-7	
<b>Pb</b> ,	74AHCT1G00SE-7	SE	SOT353	3000/Tape & Reel	-7	

 Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. Notes:

## **Marking Information**

#### (Top View)

XX Y W X

3

XX: Identification code

Y: Year 0~9

<u>W</u>: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents 52 and 53 week

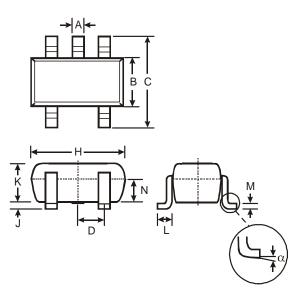
X: A~Z: Internal code

Part Number	Package	Identification Code
74AHCT1G00W5	SOT25	ZR
74AHCT1G00SE	SOT353	ZR



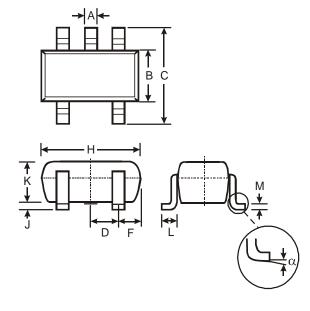
## Package Outline Dimensions (All Dimensions in mm)

#### (1) Package Type: SOT25



	SOT25						
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D	_	_	0.95				
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
K	1.00	1.30	1.10				
L	0.35	0.55	0.40				
М	0.10	0.20	0.15				
Ν	0.70	0.80	0.75				
α	0°	8°	_				
All Dimensions in mm							

#### (2) Package Type: SOT353



SOT353						
Dim	Min	Max				
Α	0.10	0.30				
В	1.15	1.35				
C	2.00	2.20				
D	0.65	Тур				
F	0.40	0.45				
Η	1.80	2.20				
J	0	0.10				
K	0.90	1.00				
L	0.25	0.40				
М	0.10	0.22				
α	0°	8°				
All Dimensions in mm						



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